TOSHIBA Bipolar Digital Integrated Circuit Silicon Monolithic

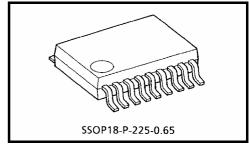
TD62382AFNG

8ch Low Input Active Darlington Sink Driver

This device can be operated by source input voltage and is suitable for operation with a 5-V general pourposed logic IC such as TTL, 5-V CMOS and 5-V Microprocessor which have sink current output drivers.

Applications include relay, hammer, lamp and LED display drivers.

Please observe the thermal condition for using.

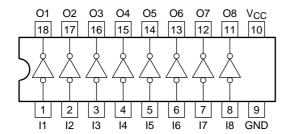


Weight: 0.09 g (typ.)

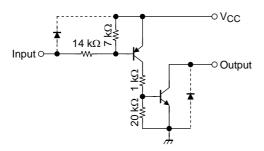
Features

- Low Saturation Output: 0.23 V (max)
 - @ $I_{out} = 40 \text{ mA (max)}$
- Package type: SSOP18 pin (0.65 mm pitch)
- Output rating: 50 V (min)/50 mA (max)
- Low level active input
- Input compatible with TTL and 5-V CMOS
- · Standard supply voltage

Pin Assignment (top view)



Schematics (each driver)



Note: The input and output parasitic diodes cannot be used as clamp diodes.

Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit	
Supply voltage	V _{CC}	-0.5~7.0	V	
Output sustaining voltage	V _{CE} (SUS)	-0.5~50	V	
Output current	lout	50	mA/ch	
Input voltage	V _{IN}	-22~V _{CC} + 0.5	٧	
Input current	I _{IN}	10	mA	
Power dissipation	P _D (Note)	0.96	W	
Operating temperature	T _{opr}	-40~85	°C	
Storage temperature	T _{stg}	-55~150	°C	

Note: On Glass Epoxy PCB ($50 \times 50 \times 1.6$ mm Cu 40%)

Recommended Operating Conditions ($Ta = -40 \sim 85$ °C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Supply voltage		V _{CC}	_	4.5	5.0	5.5	V
Output sustaining voltage		V _{CE} (SUS)	_	0	_	50	V
Output current		lour	DC 1 Circuit	0	_	40	mA/ch
		lout	8 Circuits	0	_	40	
		V _{IN}	_	-20	_	V _{CC}	
Input voltage	Output on	VIN (ON)	_	-20		V _{CC} – 3.5	V
	Output off	VIN (OFF)	_	V _{CC} - 0.3	_	V _{CC} + 0.5	
Power dissipation P _I		P _D (Note)	_	_	_	0.4	W

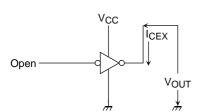
Note: On Glass Epoxy PCB (50 x 50 x 1.6 mm Cu 40%)

Electrical Characteristics (Ta = 25°C)

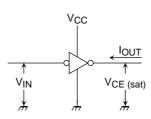
Characteristics		Symbol	Test Circuit	Test Condition		Min	Тур.	Max	Unit
Output leakage current		I _{CEX}	1	V _{CC} = 5.5 V, I _{IN} = 0 A V _{OUT} = 35 V, Ta = 75°C		_	_	100	μА
Output saturation voltage		V _{CE} (sat)	2	$V_{CC} = 4.5 \text{ V}, V_{IN} = 0.8 \text{ V}$ $I_{OUT} = 40 \text{ mA}$		_	_	0.23	V
Input current	Output on	I _{IN (ON)}	3	V _{CC} = 5.5 V, V _{IN} = 0.4 V		_	-0.32	-0.45	mA
				$V_{CC} = 5.5 \text{ V}, V_{IN} = -20 \text{ V}$		_	_	-2.6	
	Output off	I _{IN} (OFF)	4	_		_	_	-40	μА
Input voltage (Output on)		V _{IN} (ON)	5	_		-20	_	V _{CC} - 3.5	٧
Supply current	Output on	I _{CC} (ON)		V _{CC} = 5.5 V, V _{IN} = 0 V		_	_	6	mA/ch
	Output off	ICC (OFF)	6	V _{CC} = V _{IN} = 5.5 V Ta = 75°C		_	_	100	μА
Turn-on delay		ton	7	V _{CC} = 5 V C _L = 15 pF	$V_{OUT} = 50 \text{ V}$ $R_L = 1 \text{ k}\Omega$	_	0.1	_	0
Turn-off delay		tOFF			V _{OUT} = 50 V R _L = 1 kΩ	_	3.0	_	μS

Test Circuit

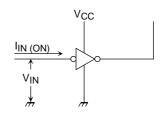
1. ICEX



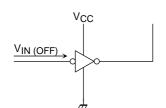
2. VCE (sat)



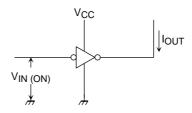
3. I_{IN} (ON)



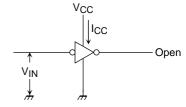
4. I_{IN} (OFF)



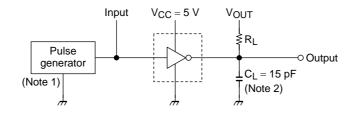
5. V_{IN} (ON)

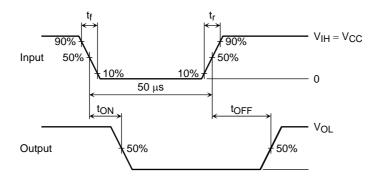


6. Icc



7. ton, toff





Note 1: Pulse width 50 μs, Duty cycle 10%

Output impedance 50 Ω , $t_f \le 10$ ns, $t_f \le 5$ ns

Note 2: C_L includes probe and jig capacitance.

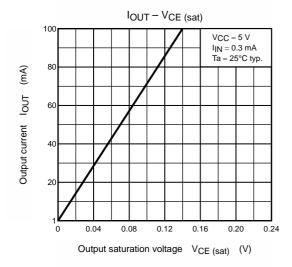
Precautions for Using

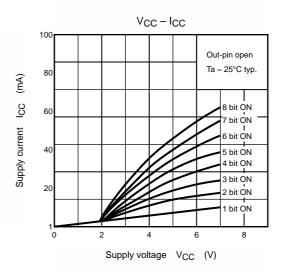
This IC does not include built-in protection circuits for excess current or overvoltage.

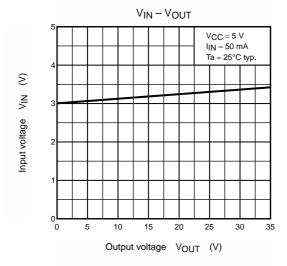
If this IC is subjected to excess current or overvoltage, it may be destroyed.

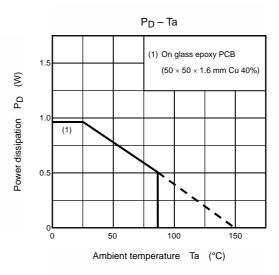
Hence, the utmost care must be taken when systems which incorporate this IC are designed.

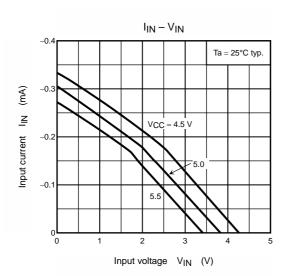
Utmost care is necessary in the design of the output line, VCC and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.







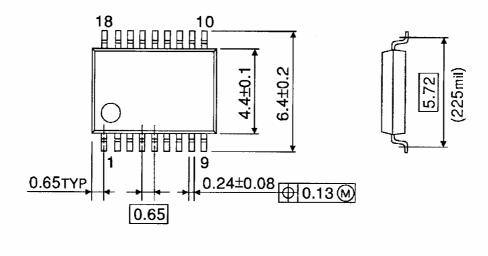


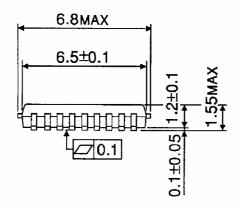


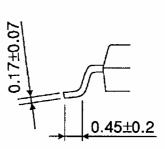
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Package Dimensions

SSOP18-P-225-0.65 Unit: mm







Weight: 0.09 g (typ.)

5 2004-02-18

About solderability, following conditions were confirmed

- Solderability
 - (1) Use of Sn-63Pb solder Bath
 - solder bath temperature = 230°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - use of R-type flux
 - (2) Use of Sn-3.0Ag-0.5Cu solder Bath
 - · solder bath temperature = 245°C
 - · dipping time = 5 seconds
 - · the number of times = once
 - · use of R-type flux

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